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PATENT
Attorney Docket No.: A7600P1/T51700
AMAT No.:
7600/P1/DSM/HDP/CVD/JPFEIFER
TTC No.: 016301-051700US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Hemant P. Mungekar et al.

Application No.: 10/660,813

Filed: September 12, 2003

For: REACTIVE ION ETCHING FOR
SEMICONDUCTOR DEVICE
FEATURE TOPOGRAPHY
MODIFICATION

Customer No.: 57385

Confirmation No. 7055

Examiner: Rodney Glenn McDonald

Technology Center/Art Unit: 1795

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Commissioner:

In response to the Office Action mailed February 27, 2009, please enter the
following amendments and remarks:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this
paper.

Remarks/Arguments begin on page 6 of this paper.